MITSUBISHI IGBT MODULES

CM100RL-24NF

HIGH POWER SWITCHING USE



APPLICATION

AC drive inverters & Servo controls, etc





HIGH POWER SWITCHING USE

ABSOLUTE MAXIMUM RATINGS (Tj = 25° C, unless otherwise specified) INVERTER PART

Symbol	Parameter	Conditions	Ratings	Unit
VCES	Collector-emitter voltage	G-E Short	1200	V
VGES	Gate-emitter voltage	C-E Short	±20	V
IC	Collector overent	DC, Tc = $80^{\circ}C^{*1}$	100	Α
Ісм	Collector current	Pulse (Note 2)	200	Α
IE (Note 1)			100	Α
IEM (Note 1)		Pulse (Note 2)	200	A
PC (Note 3)	Maximum collector dissipation	$TC = 25^{\circ}C$	620	W

BRAKE PART

Symbol	Parameter	Conditions	Ratings	Unit
VCES	Collector-emitter voltage	G-E Short	1200	V
VGES	Gate-emitter voltage	C-E Short	±20	V
IC	Collector overent	DC, TC = $94^{\circ}C^{*1}$	50	Α
Ісм	Collector current	Pulse (Note 2)	100	Α
PC (Note 3)	Maximum collector dissipation	$TC = 25^{\circ}C$	390	W
VRRM	Repetitive peak reverse voltage	Clamp diode part	1200	V
IFM	Forward current	Clamp diode part	50	A

(COMMON RATING)

Symbol	Parameter	Conditions	Ratings	Unit
Tj	Junction temperature		-40 ~ +150	°C
Tstg	Storage temperature		-40 ~ +125	°C
Viso	Isolation voltage	Terminals to base plate, f = 60Hz, AC 1 minute	2500	Vrms
_	Torquo strongth	Main terminals M5 screw	2.5 ~ 3.5	N•m
_		Mounting M5 screw	2.5 ~ 3.5	N•m
_	Weight	Typical value	350	g



HIGH POWER SWITCHING USE

ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified) **INVERTER PART**

O. make at	Parameter	Test conditions		Limits			1.1 14
Symbol				Min.	Тур.	Max.	Unit
ICES	Collector cutoff current	VCE = VCES, VGE = 0V		—	—	1	mA
VGE(th)	Gate-emitter threshold voltage	IC = 10mA, VCE = 10V		6	7	8	V
IGES	Gate leakage current	\pm VGE = VGES, VCE = 0V			—	0.5	μA
Vor())			Tj = 25°C	—	2.1	3.0	- v
VCE(sat)	Collector-emitter saturation voltage	IC = 100A, VGE = 15V	Tj = 125°C	—	2.4	—	
Cies	Input capacitance	V(0= 40)/		—	—	17.5	nF
Coes	Output capacitance	VCE = 10V VGE = 0V		—	—	1.5	nF
Cres	Reverse transfer capacitance			—	—	0.34	nF
QG	Total gate charge	VCC = 600V, IC = 100A, V	—	500	—	nC	
td(on)	Turn-on delay time			_	—	100	ns
tr	Turn-on rise time	VCC = 600V, IC = 100A	—	—	70	ns	
td(off)	Turn-off delay time	$VGE = \pm 15V$		_	—	300	ns
tr	Turn-off fall time	$RG = 3.1\Omega$, Inductive load		—	—	350	ns
trr (Note 1)	Reverse recovery time	IE = 100A		—	—	150	ns
Qrr (Note 1)	Reverse recovery charge			_	4.8	—	μC
VEC(Note 1)	Emitter-collector voltage	IE = 100A, VGE = 0V	—	—	3.8	V	
Rth(j-c)Q	Thermal registeres	IGBT part (1/6 module)*1			—	0.20	K/W
Rth(j-c)R	Thermal resistance	FWDi part (1/6 module) ^{*1}		—	—	0.28	K/W
Rth(c-f)	Contact thermal resistance	Case to heat sink, Thermal	_	0.085	_	K/W	
Rg	External gate resistance		3.1	_	42	Ω	

BRAKE PART

Cumhal	Parameter	Test conditions		Limits			1.1
Symbol				Min.	Тур.	Max.	Unit
ICES	Collector cutoff current	VCE = VCES, VGE = 0V		—	—	1	mA
VGE(th)	Gate-emitter threshold voltage	IC = 5.0mA		6	7	8	V
IGES	Gate leakage current	$\pm V$ GE = VGES, VCE = 0V			—	0.5	μA
	Collector-emitter saturation voltage	IC = 50A, VGE = 15V	$T_j = 25^{\circ}C$		2.1	3.0	N
VCE(sat)			Tj = 125°C	_	2.4	—	V
Cies	Input capacitance	V/0= 10V/			_	8.5	nF
Coes	Output capacitance	VCE = 10V VGE = 0V		_	_	0.75	nF
Cres	Reverse transfer capacitance				_	0.17	nF
QG	Total gate charge	VCC = 600V, IC = 50A, VGE = 15V		_	250	—	nC
VFM	Forward voltage drop	IF = 50A			—	3.8	V
Rth(j-c)Q	Thormal registered IGBT part ^{*1}			—	—	0.32	K/W
Rth(j-c)R	Thermal resistance	Clamp diode part ^{*1}			—	0.43	K/W
RG	External gate resistance			6.3	—	63	Ω

*1 : Case temperature (Tc) measured point is just under the chips. If you use this value, Rth(f-a) should be measured just under the chips.
*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].

Note 1. IE, VEC, trr & Qrr represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).

Pulse width and repetition rate should be such that the device junction temperature (Tj) does not exceed Tjmax rating.
Junction temperature (Tj) should not increase beyond 150°C.
Pulse width and repetition rate should be such as to cause negligible temperature rise.



HIGH POWER SWITCHING USE





COLLECTOR-EMITTER VOLTAGE VCE (V)

COLLECTOR-EMITTER SATURATION



GATE-EMITTER VOLTAGE VGE (V)





COLLECTOR CURRENT IC (A)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



EMITTER-COLLECTOR VOLTAGE VEC (V)





HIGH POWER SWITCHING USE





HIGH POWER SWITCHING USE





Important Notice

The information contained in this datasheet shall in no event be regarded as a guarantee of conditions or characteristics. This product has to be used within its specified maximum ratings, and is subject to customer's compliance with any applicable legal requirement, norms and standards.

Except as otherwise explicitly approved by Mitsubishi Electric Corporation in a written document signed by authorized representatives of Mitsubishi Electric Corporation, our products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

In usage of power semiconductor, there is always the possibility that trouble may occur with them by the reliability lifetime such as Power Cycle, Thermal Cycle or others, or when used under special circumstances (e.g. condensation, high humidity, dusty, salty, highlands, environment with lots of organic matter / corrosive gas / explosive gas, or situations which terminals of semiconductor products receive strong mechanical stress). Therefore, please pay sufficient attention to such circumstances. Further, depending on the technical requirements, our semiconductor products may contain environmental regulation substances, etc. If there is necessity of detailed confirmation, please contact our nearest sales branch or distributor.

The contents or data contained in this datasheet are exclusively intended for technically trained staff. Customer's technical departments should take responsibility to evaluate the suitability of Mitsubishi Electric Corporation product for the intended application and the completeness of the product data with respect to such application. In the customer's research and development, please evaluate it not only with a single semiconductor product but also in the entire system, and judge whether it's applicable. As required, pay close attention to the safety design by installing appropriate fuse or circuit breaker between a power supply and semiconductor products to prevent secondary damage. Please also pay attention to the application note and the related technical information.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- •These materials are intended as a reference to assist our customers in the selection of the Mitsubishi Electric Semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party.
- •Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any thirdparty's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- •All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor for the latest product information before purchasing a product listed herein.

The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.

Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Electric Semiconductor home page (http://www.MitsubishiElectric.com/semiconductors/).

- •When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- •Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- •The prior written approval of Mitsubishi Electric Corporation is necessary to reprint or reproduce in whole or in part these materials.
- •If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.

Any diversion or re-export contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.

•Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor for further details on these materials or the products contained therein.

Generally the listed company name and the brand name are the trademarks or registered trademarks of the respective companies.